

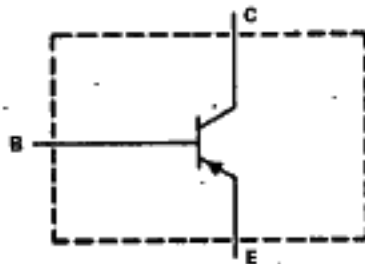
TIP74, TIP74A, TIP74B, TIP74C
P-N-P SILICON POWER TRANSISTORS

FEBRUARY 1977 - REVISED OCTOBER 1984

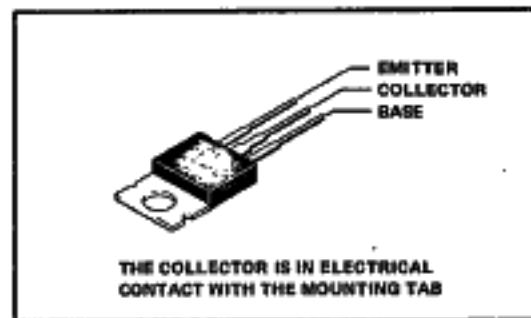
7-33-21

- Designed for Complementary Use with TIP73, TIP73A, TIP73B, TIP73C
- 80 W at 25°C Case Temperature
- 15 A Continuous Collector Current
- Min f_T of 5 MHz at 4 V, 1 A
- Meet or Surpass all JEDEC Registered Specifications for 2N6489, 2N6490, and 2N6491 at 25°C
- Designed for Power Amplifier and High-Speed Switching Applications

device schematic



TO-220AB PACKAGE



absolute maximum ratings at 25°C case temperature (unless otherwise noted)

| | TIP74 | TIP74A | TIP74B | TIP74C |
|--|----------------|--------|--------|--------|
| Collector-base voltage | -50V | -70V | -80V | -110V |
| Collector-emitter voltage ($I_B = 0$) | -40V | -60V | -80V | -100V |
| Emitter-base voltage | -5V | | | |
| Continuous collector current | -15A | | | |
| Continuous base current | -6A | | | |
| Safe operating areas at (or below) 25°C case temperature | See Figure 9 | | | |
| Continuous device dissipation at (or below) 25°C case temperature (see Note 1) | 80W | | | |
| Continuous device dissipation at (or below) 25°C free-air temperature (see Note 2) | 2W | | | |
| Unclamped inductive load energy (see Note 3) | 90mJ | | | |
| Operating collector junction and storage temperature range | -65°C to 180°C | | | |
| Lead temperature 3,2 mm (0.125 inch) from case for 10 seconds | 260°C | | | |

- NOTES: 1. Derate linearly to 150°C case temperature at the rate of 0.64 W/°C or refer to Dissipation Derating Curve, Figure 10.
 2. Derate linearly to 150°C free-air temperature at the rate of 16 mW/°C or refer to Dissipation Derating Curve, Figure 11.
 3. This rating is based on the capability of the transistor to operate safely in the circuit of Figure 2. $L = 20$ mH, $R_{BB2} = 100 \Omega$, $V_{BB2} = 0$ V, $R_B = 0.1 \Omega$, $V_{CC} = -20$ V. Energy $= I_C^2 L / 2$.



TIP Devices

TIP74, TIP74A, TIP74B, TIP74C
P-N-P SILICON POWER TRANSISTORS

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electrical characteristics at 25°C case temperature (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | TIP74 | | | TIP74A | | | UNIT |
|-----------------------|---|-------|-----|------|--------|-----|------|---------------|
| | | MIN | TYP | MAX | MIN | TYP | MAX | |
| V_{BRICEO} | $I_C = -200\text{ mA}$, $I_B = 0$, See Note 4 | -40 | | | -60 | | | V |
| V_{BRICEV} | $I_C = -200\text{ mA}$, $V_{BE} = 1.5\text{ V}$, See Note 4 | -60 | | | -70 | | | V |
| I_{CEO} | $V_{CE} = -30\text{ V}$, $I_B = 0$ | | | -50 | | -50 | | μA |
| I_{CES} | $V_{CE} = -40\text{ V}$, $V_{BE} = 0$ | | | -50 | | | | μA |
| | $V_{CE} = -60\text{ V}$, $V_{BE} = 0$ | | | | | -50 | | μA |
| I_{EBO} | $V_{EB} = -5\text{ V}$, $I_C = 0$ | | | -50 | | -50 | | μA |
| h_{FE} | $V_{CE} = -4\text{ V}$, $I_C = -5\text{ A}$, See Notes 4 and 5 | 20 | | 150 | 20 | | 150 | |
| | $V_{CE} = -4\text{ V}$, $I_C = -15\text{ A}$, See Notes 4 and 5 | 5 | | | 5 | | | |
| V_{BE} | $V_{CE} = -4\text{ V}$, $I_C = -5\text{ A}$, See Notes 4 and 5 | | | -1.3 | | | -1.3 | V |
| | $V_{CE} = -4\text{ V}$, $I_C = -15\text{ A}$, See Notes 4 and 5 | | | -3.5 | | | -3.5 | V |
| $V_{CE(\text{test})}$ | $I_B = -500\text{ mA}$, $I_C = -5\text{ A}$, See Notes 4 and 5 | | | -1.3 | | | -1.3 | V |
| | $I_B = -5\text{ A}$, $I_C = -15\text{ A}$, See Notes 4 and 5 | | | -3.5 | | | -3.5 | V |
| h_{fe} | $V_{CE} = -4\text{ V}$, $I_C = -1\text{ A}$, $f = 1\text{ kHz}$ | 25 | | | 25 | | | |
| $[h_{fe}]$ | $V_{CE} = -4\text{ V}$, $I_C = -1\text{ A}$, $f = 1\text{ MHz}$ | 5 | | | 5 | | | |

electrical characteristics at 25°C case temperature (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | TIP74B | | | TIP74C | | | UNIT |
|-----------------------|---|--------|-----|------|--------|-----|------|---------------|
| | | MIN | TYP | MAX | MIN | TYP | MAX | |
| V_{BRICEO} | $I_C = -200\text{ mA}$, $I_B = 0$, See Note 4 | -60 | | | -100 | | | V |
| V_{BRICEV} | $I_C = -200\text{ mA}$, $I_B = 0$, See Note 4 | -90 | | | -110 | | | V |
| I_{CEO} | $V_{CE} = -60\text{ V}$, $I_B = 0$ | | | -50 | | -50 | | μA |
| I_{CES} | $V_{CE} = -80\text{ V}$, $V_{BE} = 0$ | | | -50 | | | | μA |
| | $V_{CE} = -100\text{ V}$, $V_{BE} = 0$ | | | | | -50 | | μA |
| I_{EBO} | $V_{EB} = -5\text{ V}$, $I_C = 0$ | | | -50 | | -50 | | μA |
| h_{FE} | $V_{CE} = -4\text{ V}$, $I_C = -5\text{ A}$, See Notes 4 and 5 | 20 | | 150 | 20 | | 150 | |
| | $V_{CE} = -4\text{ V}$, $I_C = -15\text{ A}$, See Notes 4 and 5 | 5 | | | 5 | | | |
| V_{BE} | $V_{CE} = -4\text{ V}$, $I_C = -5\text{ A}$, See Notes 4 and 5 | | | -1.3 | | | -1.3 | V |
| | $V_{CE} = -4\text{ V}$, $I_C = -15\text{ A}$, See Notes 4 and 5 | | | -3.5 | | | -3.5 | V |
| $V_{CE(\text{test})}$ | $I_B = -500\text{ mA}$, $I_C = -5\text{ A}$, See Notes 4 and 5 | | | -1.3 | | | -1.3 | V |
| | $I_B = -5\text{ A}$, $I_C = -15\text{ A}$, See Notes 4 and 5 | | | -3.5 | | | -3.5 | V |
| h_{fe} | $V_{CE} = -4\text{ V}$, $I_C = -1\text{ A}$, $f = 1\text{ kHz}$ | 25 | | | 25 | | | |
| $[h_{fe}]$ | $V_{CE} = -4\text{ V}$, $I_C = -1\text{ A}$, $f = 1\text{ MHz}$ | 5 | | | 5 | | | |

- NOTES: 4. These parameters must be measured using pulse techniques, $t_{PW} = 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
5. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3.2 mm (0.125 inch) from the device body.

thermal characteristics

| PARAMETER | MIN | TYP | MAX | UNIT |
|-------------------------------|-----|------|-----|-----------------------------|
| $R_{\theta JC}$ | | 1.55 | | $^{\circ}\text{C/W}$ |
| $R_{\theta JA}$ | | 62.5 | | $^{\circ}\text{C/W}$ |
| $R_{\theta CHS}$ (see Note 6) | 0.7 | | | $^{\circ}\text{C/W}$ |
| $C_{\theta C}$ | 0.9 | | | $\text{J}/^{\circ}\text{C}$ |

NOTE 6: This parameter is measured using 0.08 mm (0.003 inch) mica insulator with Dow-Corning 11 compound on both sides of the insulator, a 0.138-32 (formerly 6-32) mounting screw with bushing, and a mounting torque of 0.9 newton-meter (8 inch-pounds).

TIP Devices

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P-N-P SILICON POWER TRANSISTORS

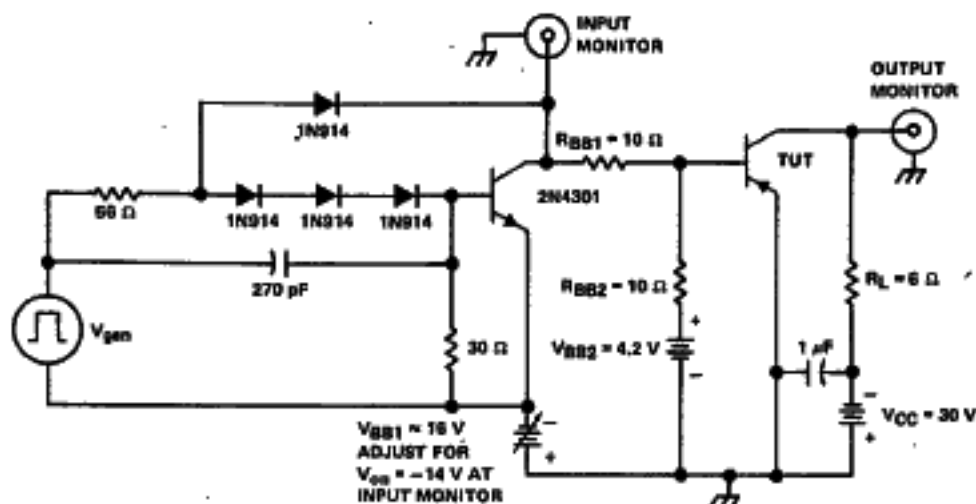
T-33-21

resistive-load switching characteristics at 25°C case temperature (unless otherwise noted)

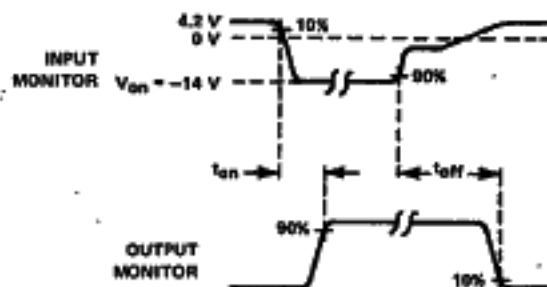
| PARAMETER | TEST CONDITIONS† | MIN | TYP | MAX | UNIT |
|-----------|--|-----|-----|-----|------|
| t_d | | | 20 | | ns |
| t_r | $I_C = -5A, I_{B1} = -0.5A, I_{B2} = 0.5A,$ $V_{BE(off)} = 4.2V, R_L = 6\Omega,$ See Figure 1 | | 120 | | ns |
| t_s | | | 600 | | ns |
| t_f | | | 300 | | ns |

†Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



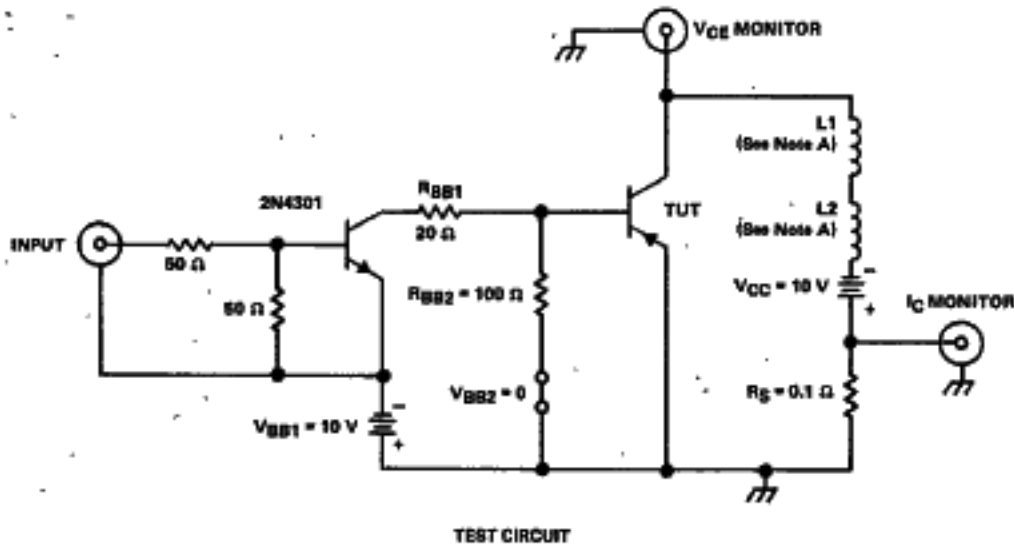
VOLTAGE WAVEFORMS

- NOTES: A. V_{gen} is a 30-V pulse into a 50 Ω termination.
 B. The V_{gen} waveform is supplied by a generator with the following characteristics: $t_r \leq 15$ ns, $t_f \leq 15$ ns, $Z_{out} = 50 \Omega$, $t_{pw} = 20$ ns, duty cycle $\leq 2\%$.
 C. Waveforms are monitored on an oscilloscope with the following characteristics: $t_f \leq 15$ ns, $R_{in} > 10$ M Ω , $C_{in} \leq 11.5$ pF.
 D. Resistors must be noninductive types.
 E. The d-c power supplies may require additional bypassing in order to minimize ringing.

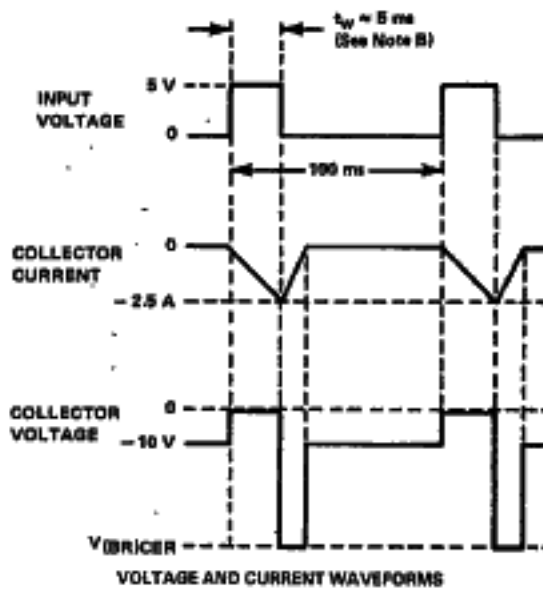
FIGURE 1. RESISTIVE-LOAD SWITCHING



PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT



NOTES: A. L1 and L2 are 10 mH, 0.11 Ω, Chicago Standard Transformer Corporation C-2688, or equivalent.
B. Input pulse duration is increased until I_{CM} = -3 A.

FIGURE 2. INDUCTIVE-LOAD SWITCHING

TIP Devices

TYPICAL CHARACTERISTICS

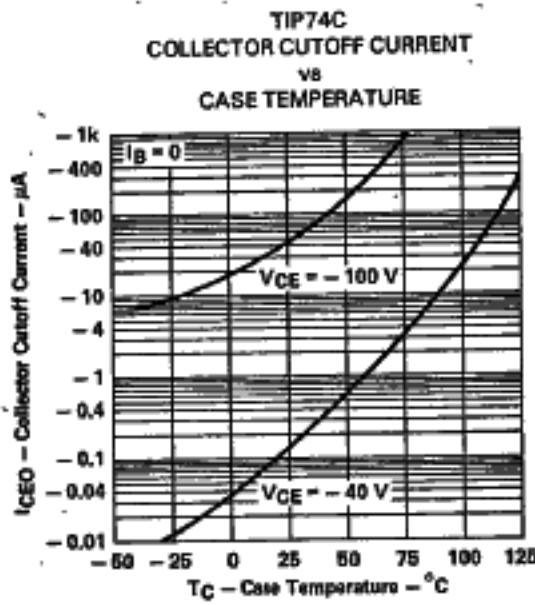


FIGURE 3

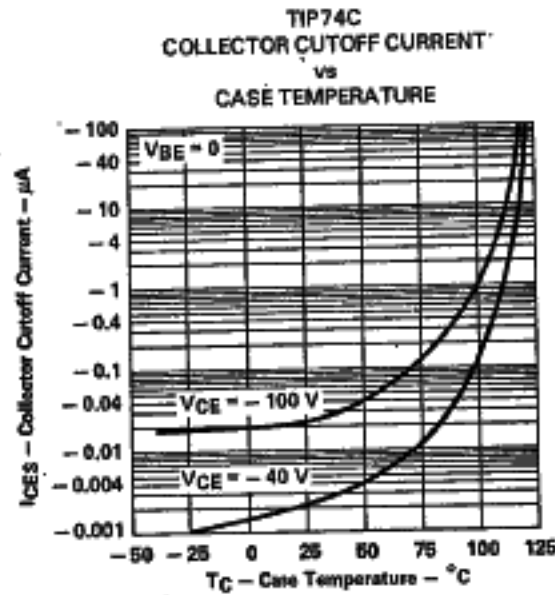


FIGURE 4

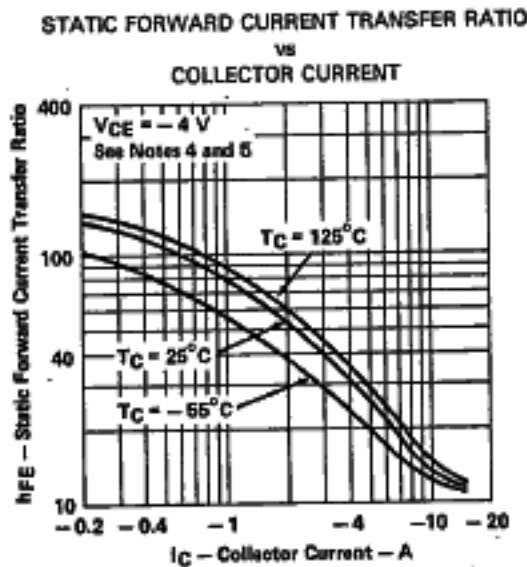


FIGURE 5

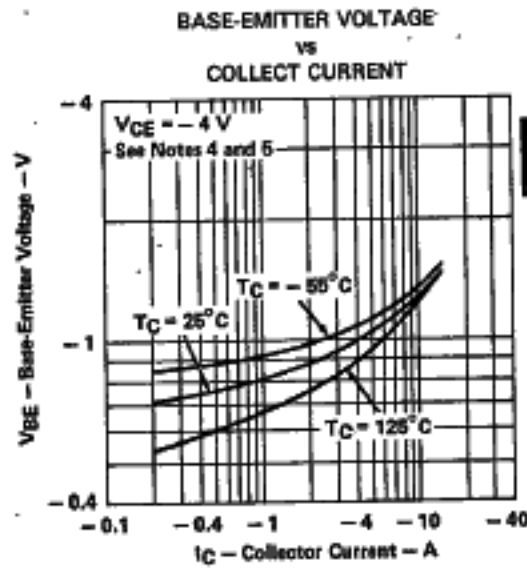


FIGURE 6

- NOTES: 4. These parameters must be measured using pulse techniques, $t_w = 300 \mu s$, duty cycle $< 2\%$.
5. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3,2 mm (0.125 inch) from the device body.

5
TIP Devices

TYPICAL CHARACTERISTICS

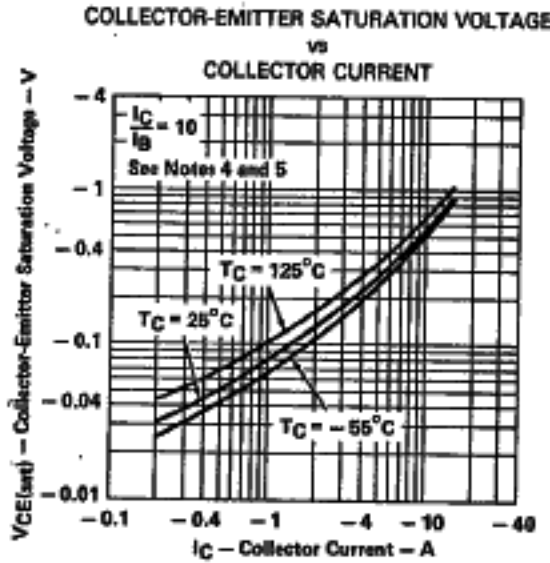


FIGURE 7

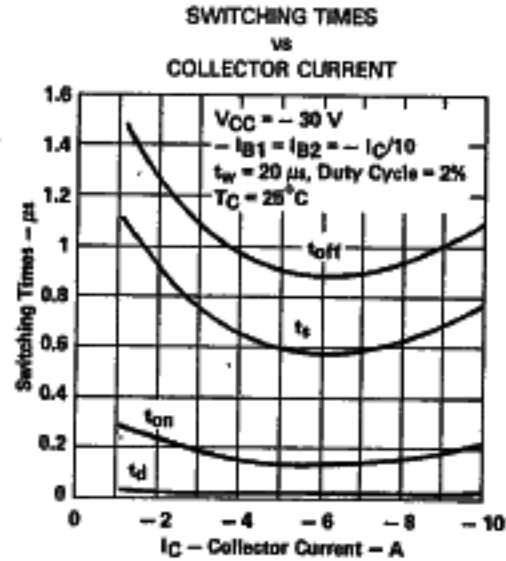


FIGURE 8

- NOTES: 4. These parameters must be measured using pulse techniques, $t_w = 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
5. These parameters are measured with voltage-sensing contacts separate from the current-carrying contacts and located within 3.2 mm (0.125 inch) from the device body.

MAXIMUM SAFE OPERATING AREA

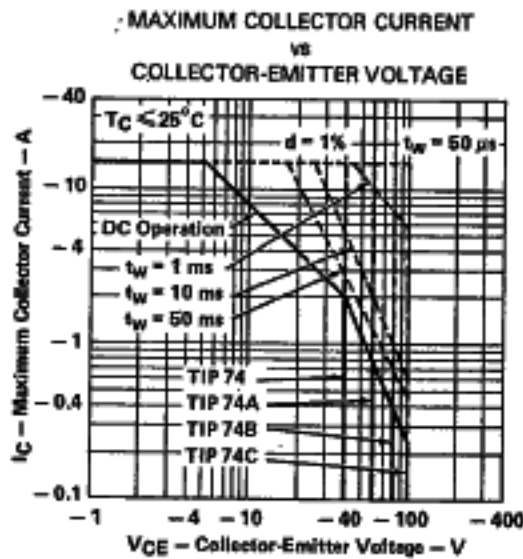


FIGURE 9



TIP Devices

THERMAL INFORMATION

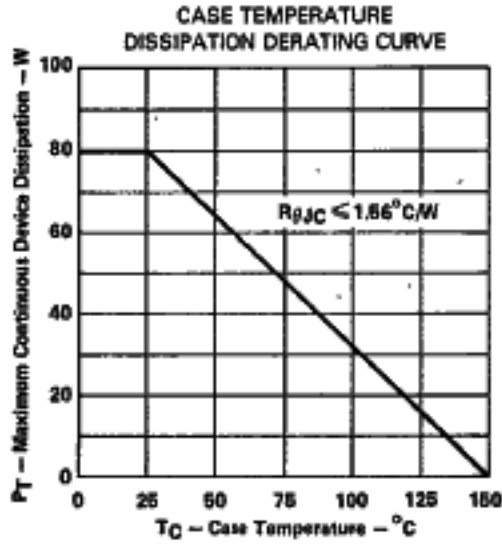


FIGURE 10

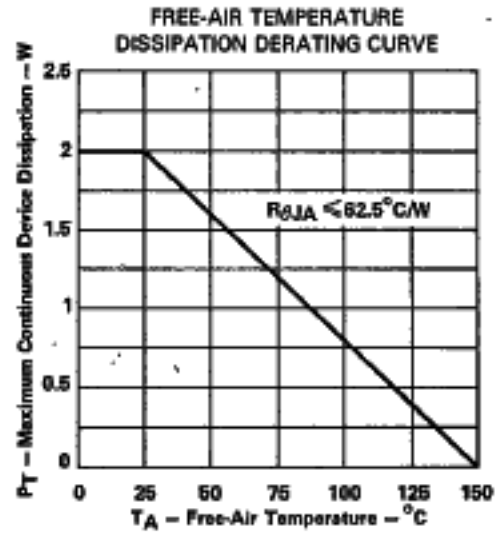


FIGURE 11



TIP Devices